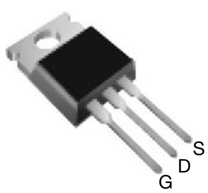
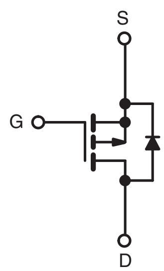
Power MOSFET

PRODUCT SUMMARY		
V_{DS} (V)	- 100	
$R_{DS(on)}$ (Ω)	V_{GS} = - 10 V	0.60
Q_g (Max.) (nC)	18	
Q_{gs} (nC)	3.0	
Q_{gd} (nC)	9.0	
Configuration	Single	

TO-220AB





P-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

Pb Available
RoHS*
COMPLIANT

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF9520PbF
	SiHF9520-E3
SnPb	IRF9520
	SiHF9520

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	- 100	V
Gate-Source Voltage			V_{GS}	± 20	
Continuous Drain Current	V_{GS} at - 10 V	T_C = 25 °C	I_D	- 6.8	A
		T_C = 100 °C		- 4.8	
Pulsed Drain Current[a]			I_{DM}	- 27	
Linear Derating Factor				0.40	W/°C
Single Pulse Avalanche Energy[b]			E_{AS}	300	mJ
Repetitive Avalanche Current[a]			I_{AR}	- 6.8	A
Repetitive Avalanche Energy[a]			E_{AR}	6.0	mJ
Maximum Power Dissipation	T_C = 25 °C		P_D	60	W
Peak Diode Recovery dV/dt[c]			dV/dt	- 5.5	V/ns
Operating Junction and Storage Temperature Range			T_J, T_{stg}	- 55 to + 175	°C
Soldering Recommendations (Peak Temperature)	for 10 s			300[d]	
Mounting Torque	6-32 or M3 screw			10	lbf · in
				1.1	N · m

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. V_{DD} = - 25 V, starting T_J = 25 °C, L = 9.7 mH, R_g = 25 Ω, I_{AS} = - 6.8 A (see fig. 12).
c. $I_{SD} \leq$ - 6.8 A, dI/dt $\leq$ 110 A/μs, $V_{DD} \leq V_{DS}$, $T_J \leq$ 175 °C.
d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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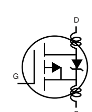
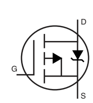
THERMAL RESISTANCE RATINGS				
PARAMETER	**SYMBOL**	**TYP.**	**MAX.**	**UNIT**
Maximum Junction-to-Ambient	R_{thJA}	-	62	°C/W
Case-to-Sink, Flat, Greased Surface	R_{thCS}	0.50	-	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	2.5	

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = - 250 μA	- 100	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, I_D = - 1 mA	-	- 0.10	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = - 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I_{GSS}	V_{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = - 100 V, V_{GS} = 0 V	-	-	- 100	μA
		V_{DS} = - 80 V, V_{GS} = 0 V, T_J = 150 °C	-	-	- 500	
Drain-Source On-State Resistance	$R_{DS(on)}$	V_{GS} = - 10 V; I_D = - 4.1 A[b]	-	-	0.60	Ω
Forward Transconductance	g_{fs}	V_{DS} = - 50 V, I_D = - 4.1 A[b]	2.0	-	-	S
Dynamic						
Input Capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = - 25 V, f = 1.0 MHz, see fig. 5	-	390	-	pF
Output Capacitance	C_{oss}		-	170	-	
Reverse Transfer Capacitance	C_{rss}		-	45	-	
Total Gate Charge	Q_g	V_{GS} = - 10 V; I_D = - 6.8 A, V_{DS} = - 80 V, see fig. 6 and 13[b]	-	-	18	nC
Gate-Source Charge	Q_{gs}		-	-	3.0	
Gate-Drain Charge	Q_{gd}		-	-	9.0	
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = - 50 V, I_D = - 6.8 A, R_g = 18 Ω, R_D = 7.1 Ω, see fig. 10[b]	-	9.6	-	ns
Rise Time	t_r		-	29	-	
Turn-Off Delay Time	$t_{d(off)}$		-	21	-	
Fall Time	t_f		-	25	-	
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact 	-	4.5	-	nH
Internal Source Inductance	L_S		-	7.5	-	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	MOSFET symbol showing the integral reverse p - n junction diode 	-	-	- 6.8	A
Pulsed Diode Forward Current[a]	I_{SM}		-	-	- 27	
Body Diode Voltage	V_{SD}	T_J = 25 °C, I_S = - 6.8 A, V_{GS} = 0 V[b]	-	-	- 6.3	V
Body Diode Reverse Recovery Time	t_{rr}	T_J = 25 °C, I_F = - 6.8 A, dI/dt = 100 A/μs[b]	-	98	200	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	0.33	0.66	μC
Forward Turn-On Time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width ≤ 300 μs; duty cycle ≤ 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

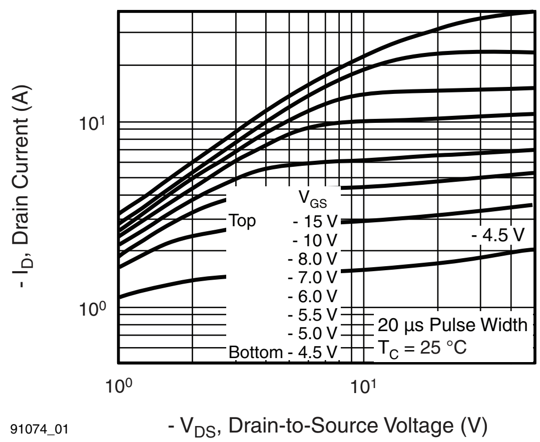

Fig. 1 - Typical Output Characteristics, T_C = 25 °C

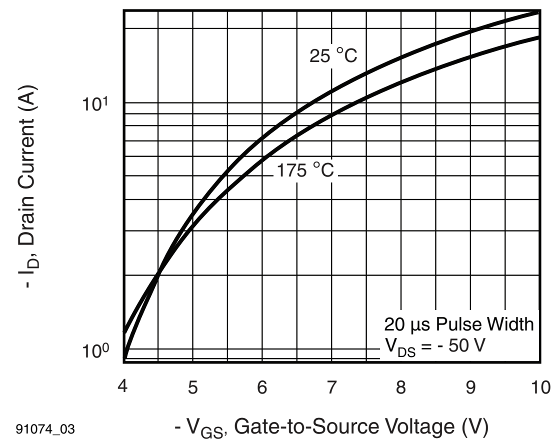

Fig. 3 - Typical Transfer Characteristics

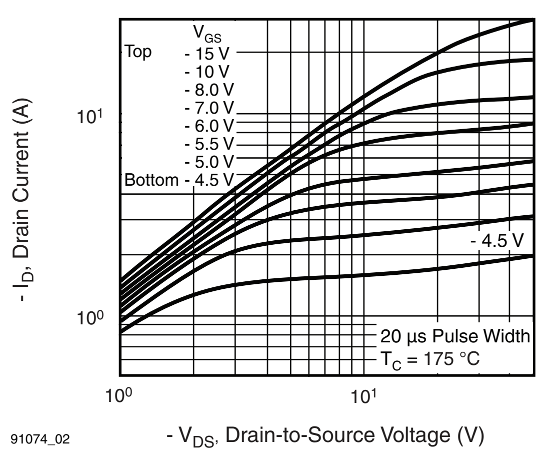

Fig. 2 - Typical Output Characteristics, T_C = 175 °C

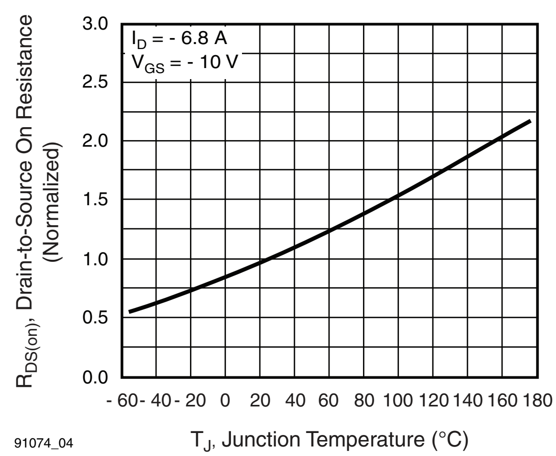

Fig. 4 - Normalized On-Resistance vs. Temperature

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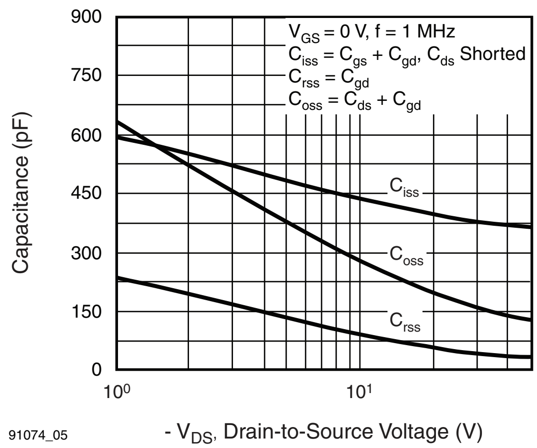

Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

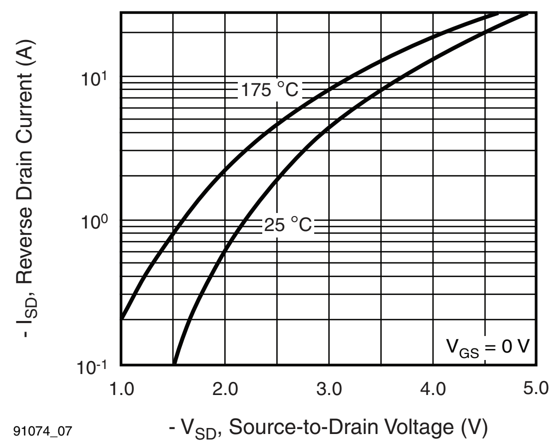

Fig. 7 - Typical Source-Drain Diode Forward Voltage

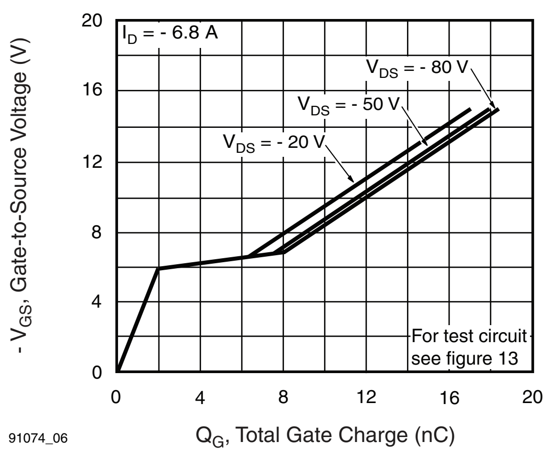

Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

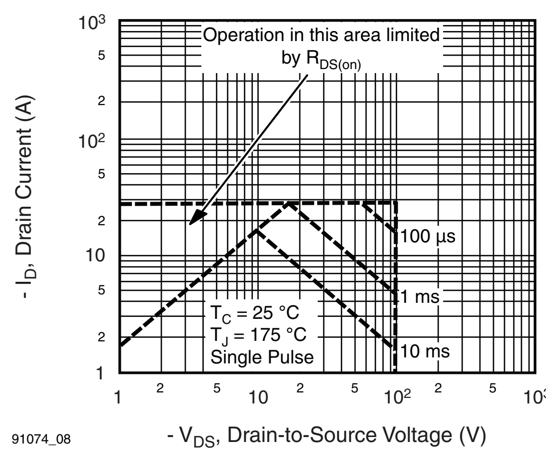

Fig. 8 - Maximum Safe Operating Area

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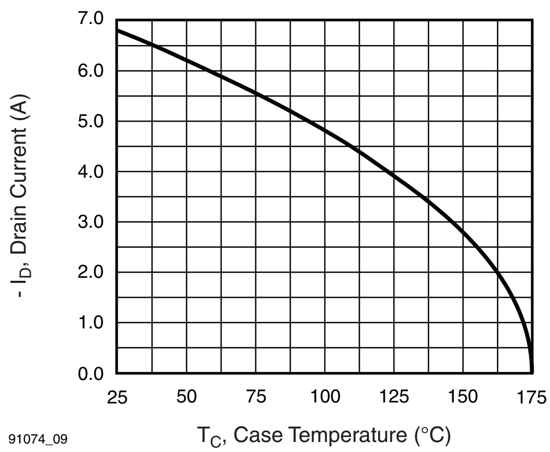

Fig. 9 - Maximum Drain Current vs. Case Temperature

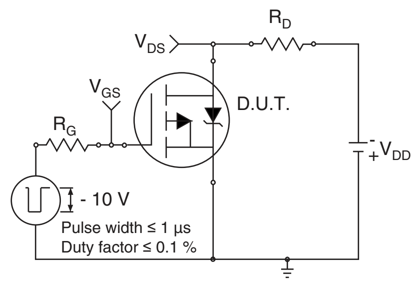

Fig. 10a - Switching Time Test Circuit

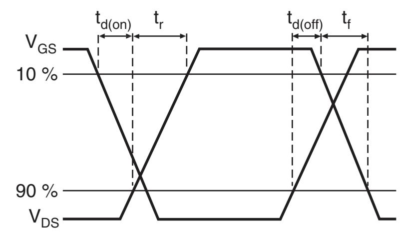

Fig. 10b - Switching Time Waveforms

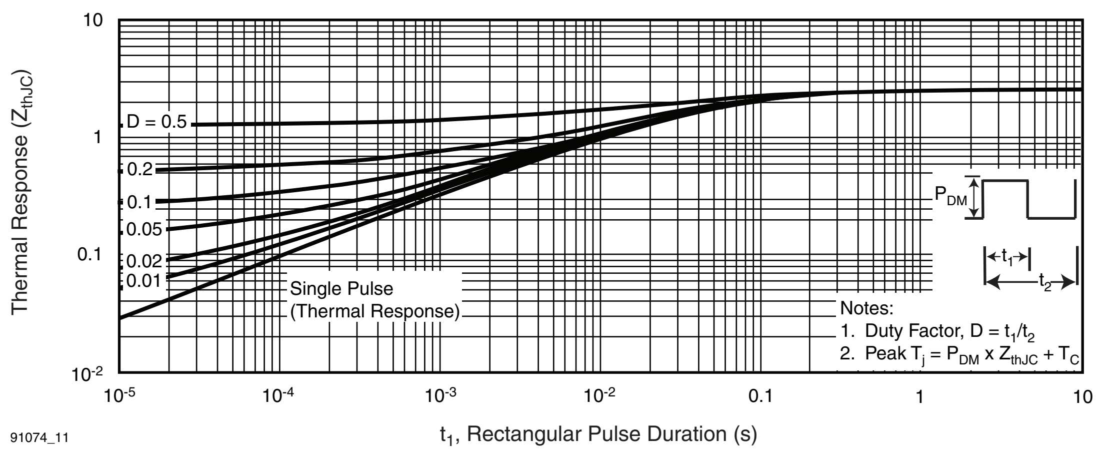

Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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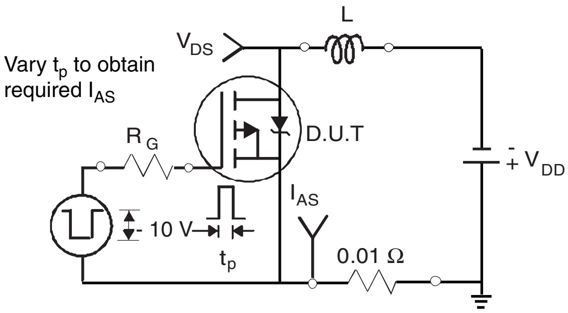

Fig. 12a - Unclamped Inductive Test Circuit

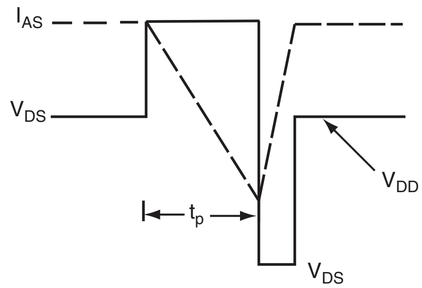

Fig. 12b - Unclamped Inductive Waveforms

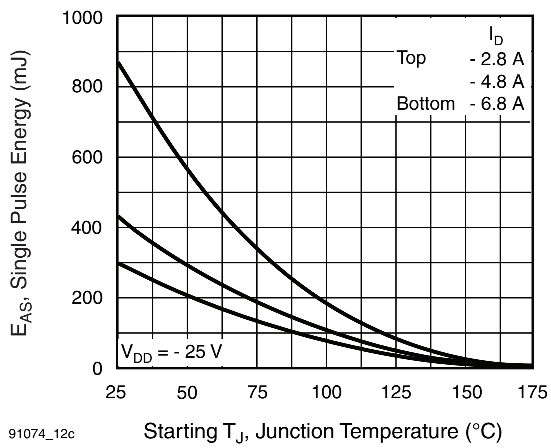

Fig. 12c - Maximum Avalanche Energy vs. Drain Current

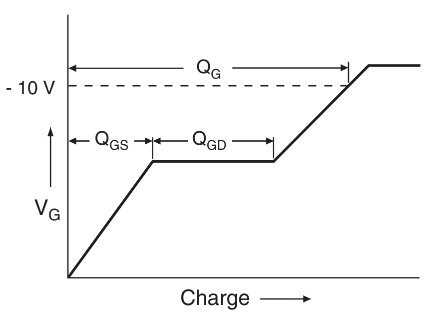

Fig. 13a - Basic Gate Charge Waveform

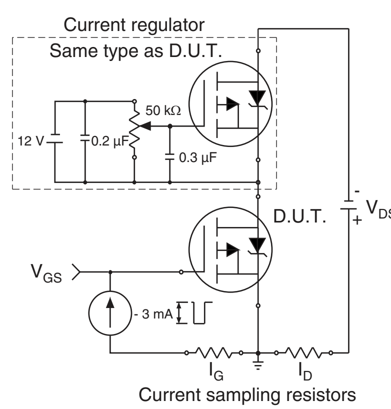

Fig. 13b - Gate Charge Test Circuit

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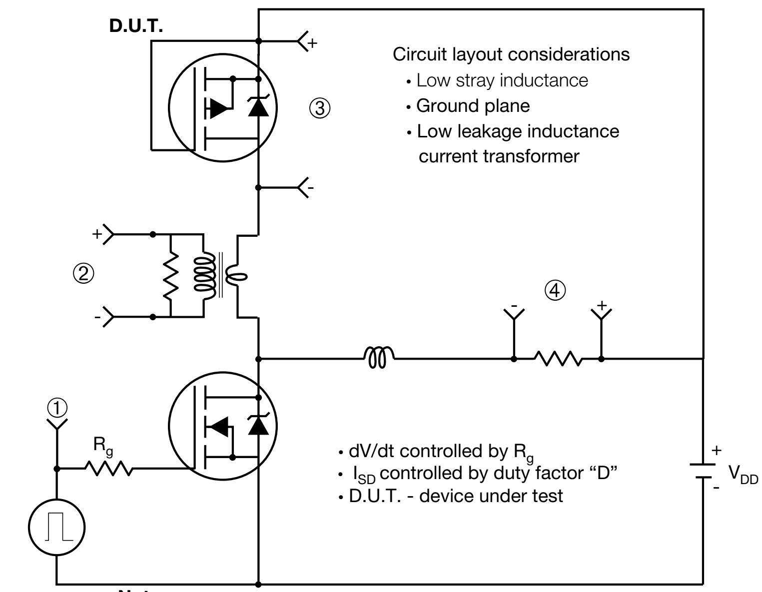
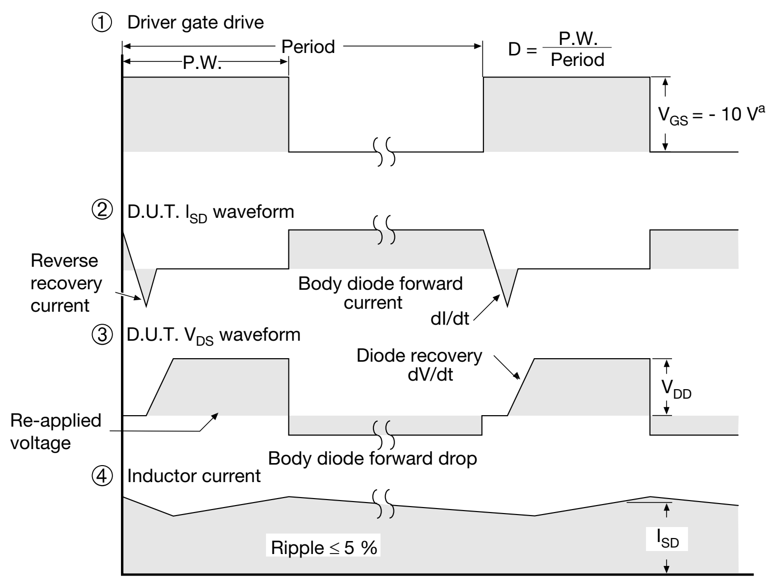
Peak Diode Recovery dV/dt Test Circuit



Note
• Compliment N-Channel of D.U.T. for driver



Note
a. V_{GS} = - 5 V for logic level and - 3 V drive devices

Fig. 14 - For P-Channel

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